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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Active  |
| Number of LABs/CLBs            | 3118  |
| Number of Logic Elements/Cells | 49888   |
| Total RAM Bits                 | 2562048   |
| Number of I/O                  | 290   |
| Number of Gates                | -   |
| Voltage - Supply               | 1.16V ~ 1.24V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | -40°C ~ 100°C (TJ)  |
| Package / Case                 | 484-BGA   |
| Supplier Device Package        | 484-FBGA (23x23)  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/ep4cgx50cf23i7">https://www.e-xfl.com/product-detail/intel/ep4cgx50cf23i7</a> |



Cyclone IV E industrial devices I7 are offered with extended operating temperature range.

## Absolute Maximum Ratings

Absolute maximum ratings define the maximum operating conditions for Cyclone IV devices. The values are based on experiments conducted with the device and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied at these conditions. Table 1–1 lists the absolute maximum ratings for Cyclone IV devices.



Conditions beyond those listed in Table 1–1 cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time have adverse effects on the device.

**Table 1–1. Absolute Maximum Ratings for Cyclone IV Devices <sup>(1)</sup>**

| Symbol          | Parameter   | Min  | Max  | Unit |
|-----------------|---|------|------|------|
| $V_{CCINT}$     | Core voltage, PCI Express® (PCIe®) hard IP block, and transceiver physical coding sublayer (PCS) power supply | –0.5 | 1.8  | V    |
| $V_{CCA}$       | Phase-locked loop (PLL) analog power supply   | –0.5 | 3.75 | V    |
| $V_{CCD\_PLL}$  | PLL digital power supply  | –0.5 | 1.8  | V    |
| $V_{CCIO}$      | I/O banks power supply  | –0.5 | 3.75 | V    |
| $V_{CC\_CLKIN}$ | Differential clock input pins power supply  | –0.5 | 4.5  | V    |
| $V_{CCH\_GXB}$  | Transceiver output buffer power supply  | –0.5 | 3.75 | V    |
| $V_{CCA\_GXB}$  | Transceiver physical medium attachment (PMA) and auxiliary power supply                                       | –0.5 | 3.75 | V    |
| $V_{CCL\_GXB}$  | Transceiver PMA and auxiliary power supply  | –0.5 | 1.8  | V    |
| $V_I$           | DC input voltage  | –0.5 | 4.2  | V    |
| $I_{OUT}$       | DC output current, per pin  | –25  | 40   | mA   |
| $T_{STG}$       | Storage temperature   | –65  | 150  | °C   |
| $T_J$           | Operating junction temperature  | –40  | 125  | °C   |

**Note to Table 1–1:**

(1) Supply voltage specifications apply to voltage readings taken at the device pins with respect to ground, not at the power supply.

## Maximum Allowed Overshoot or Undershoot Voltage

During transitions, input signals may overshoot to the voltage shown in Table 1–2 and undershoot to –2.0 V for a magnitude of currents less than 100 mA and for periods shorter than 20 ns. Table 1–2 lists the maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage over the lifetime of the device. The maximum allowed overshoot duration is specified as a percentage of high-time over the lifetime of the device.

## Recommended Operating Conditions

This section lists the functional operation limits for AC and DC parameters for Cyclone IV devices. Table 1–3 and Table 1–4 list the steady-state voltage and current values expected from Cyclone IV E and Cyclone IV GX devices. All supplies must be strictly monotonic without plateaus.

**Table 1–3. Recommended Operating Conditions for Cyclone IV E Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 2)**

| Symbol                | Parameter  | Conditions                                   | Min        | Typ | Max        | Unit |
|-----------------------|--|--|------------|-----|------------|------|
| $V_{CCINT}^{(3)}$     | Supply voltage for internal logic, 1.2-V operation | —  | 1.15       | 1.2 | 1.25       | V    |
|                       | Supply voltage for internal logic, 1.0-V operation | —  | 0.97       | 1.0 | 1.03       | V    |
| $V_{CCIO}^{(3), (4)}$ | Supply voltage for output buffers, 3.3-V operation | —  | 3.135      | 3.3 | 3.465      | V    |
|                       | Supply voltage for output buffers, 3.0-V operation | —  | 2.85       | 3   | 3.15       | V    |
|                       | Supply voltage for output buffers, 2.5-V operation | —  | 2.375      | 2.5 | 2.625      | V    |
|                       | Supply voltage for output buffers, 1.8-V operation | —  | 1.71       | 1.8 | 1.89       | V    |
|                       | Supply voltage for output buffers, 1.5-V operation | —  | 1.425      | 1.5 | 1.575      | V    |
|                       | Supply voltage for output buffers, 1.2-V operation | —  | 1.14       | 1.2 | 1.26       | V    |
| $V_{CCA}^{(3)}$       | Supply (analog) voltage for PLL regulator          | —  | 2.375      | 2.5 | 2.625      | V    |
| $V_{CCD\_PLL}^{(3)}$  | Supply (digital) voltage for PLL, 1.2-V operation  | —  | 1.15       | 1.2 | 1.25       | V    |
|                       | Supply (digital) voltage for PLL, 1.0-V operation  | —  | 0.97       | 1.0 | 1.03       | V    |
| $V_I$                 | Input voltage                                      | —  | –0.5       | —   | 3.6        | V    |
| $V_O$                 | Output voltage                                     | —  | 0          | —   | $V_{CCIO}$ | V    |
| $T_J$                 | Operating junction temperature                     | For commercial use                           | 0          | —   | 85         | °C   |
|                       |  | For industrial use                           | –40        | —   | 100        | °C   |
|                       |  | For extended temperature                     | –40        | —   | 125        | °C   |
|                       |  | For automotive use                           | –40        | —   | 125        | °C   |
| $t_{RAMP}$            | Power supply ramp time                             | Standard power-on reset (POR) <sup>(5)</sup> | 50 $\mu$ s | —   | 50 ms      | —    |
|                       |  | Fast POR <sup>(6)</sup>                      | 50 $\mu$ s | —   | 3 ms       | —    |

**Table 1–3. Recommended Operating Conditions for Cyclone IV E Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Symbol      | Parameter  | Conditions | Min | Typ | Max | Unit |
|-------------|--|------------|-----|-----|-----|------|
| $I_{Diode}$ | Magnitude of DC current across PCI-clamp diode when enable | —          | —   | —   | 10  | mA   |

**Notes to Table 1–3:**

- (1) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades.
- (2)  $V_{CCIO}$  for all I/O banks must be powered up during device operation. All  $V_{CCA}$  pins must be powered to 2.5 V (even when PLLs are not used) and must be powered up and powered down at the same time.
- (3)  $V_{CC}$  must rise monotonically.
- (4)  $V_{CCIO}$  powers all input buffers.
- (5) The POR time for Standard POR ranges between 50 and 200 ms. Each individual power supply must reach the recommended operating range within 50 ms.
- (6) The POR time for Fast POR ranges between 3 and 9 ms. Each individual power supply must reach the recommended operating range within 3 ms.

**Table 1–4. Recommended Operating Conditions for Cyclone IV GX Devices (Part 1 of 2)**

| Symbol                                   | Parameter  | Conditions | Min   | Typ | Max   | Unit |
|--|--|------------|-------|-----|-------|------|
| $V_{CCINT}$ <sup>(3)</sup>               | Core voltage, PCIe hard IP block, and transceiver PCS power supply | —          | 1.16  | 1.2 | 1.24  | V    |
| $V_{CCA}$ <sup>(1), (3)</sup>            | PLL analog power supply  | —          | 2.375 | 2.5 | 2.625 | V    |
| $V_{CCD\_PLL}$ <sup>(2)</sup>            | PLL digital power supply   | —          | 1.16  | 1.2 | 1.24  | V    |
| $V_{CCIO}$ <sup>(3), (4)</sup>           | I/O banks power supply for 3.3-V operation                         | —          | 3.135 | 3.3 | 3.465 | V    |
|  | I/O banks power supply for 3.0-V operation                         | —          | 2.85  | 3   | 3.15  | V    |
|  | I/O banks power supply for 2.5-V operation                         | —          | 2.375 | 2.5 | 2.625 | V    |
|  | I/O banks power supply for 1.8-V operation                         | —          | 1.71  | 1.8 | 1.89  | V    |
|  | I/O banks power supply for 1.5-V operation                         | —          | 1.425 | 1.5 | 1.575 | V    |
|  | I/O banks power supply for 1.2-V operation                         | —          | 1.14  | 1.2 | 1.26  | V    |
| $V_{CC\_CLKIN}$ <sup>(3), (5), (6)</sup> | Differential clock input pins power supply for 3.3-V operation     | —          | 3.135 | 3.3 | 3.465 | V    |
|  | Differential clock input pins power supply for 3.0-V operation     | —          | 2.85  | 3   | 3.15  | V    |
|  | Differential clock input pins power supply for 2.5-V operation     | —          | 2.375 | 2.5 | 2.625 | V    |
|  | Differential clock input pins power supply for 1.8-V operation     | —          | 1.71  | 1.8 | 1.89  | V    |
|  | Differential clock input pins power supply for 1.5-V operation     | —          | 1.425 | 1.5 | 1.575 | V    |
|  | Differential clock input pins power supply for 1.2-V operation     | —          | 1.14  | 1.2 | 1.26  | V    |
| $V_{CCH\_GXB}$                           | Transceiver output buffer power supply                             | —          | 2.375 | 2.5 | 2.625 | V    |

**Table 1-4. Recommended Operating Conditions for Cyclone IV GX Devices (Part 2 of 2)**

| Symbol               | Parameter   | Conditions                                   | Min   | Typ | Max               | Unit |
|----------------------|---|--|-------|-----|-------------------|------|
| V <sub>CCA_GXB</sub> | Transceiver PMA and auxiliary power supply                  | —  | 2.375 | 2.5 | 2.625             | V    |
| V <sub>CCL_GXB</sub> | Transceiver PMA and auxiliary power supply                  | —  | 1.16  | 1.2 | 1.24              | V    |
| V <sub>I</sub>       | DC input voltage  | —  | -0.5  | —   | 3.6               | V    |
| V <sub>O</sub>       | DC output voltage   | —  | 0     | —   | V <sub>CCIO</sub> | V    |
| T <sub>J</sub>       | Operating junction temperature                              | For commercial use                           | 0     | —   | 85                | °C   |
|                      |   | For industrial use                           | -40   | —   | 100               | °C   |
| t <sub>RAMP</sub>    | Power supply ramp time                                      | Standard power-on reset (POR) <sup>(7)</sup> | 50 μs | —   | 50 ms             | —    |
|                      |   | Fast POR <sup>(8)</sup>                      | 50 μs | —   | 3 ms              | —    |
| I <sub>Diode</sub>   | Magnitude of DC current across PCI-clamp diode when enabled | —  | —     | —   | 10                | mA   |

**Notes to Table 1-4:**

- (1) All V<sub>CCA</sub> pins must be powered to 2.5 V (even when PLLs are not used) and must be powered up and powered down at the same time.
- (2) You must connect V<sub>CCD\_PLL</sub> to V<sub>CCINT</sub> through a decoupling capacitor and ferrite bead.
- (3) Power supplies must rise monotonically.
- (4) V<sub>CCIO</sub> for all I/O banks must be powered up during device operation. Configurations pins are powered up by V<sub>CCIO</sub> of I/O Banks 3, 8, and 9 where I/O Banks 3 and 9 only support V<sub>CCIO</sub> of 1.5, 1.8, 2.5, 3.0, and 3.3 V. For fast passive parallel (FPP) configuration mode, the V<sub>CCIO</sub> level of I/O Bank 8 must be powered up to 1.5, 1.8, 2.5, 3.0, and 3.3 V.
- (5) You must set V<sub>CC\_CLKIN</sub> to 2.5 V if you use CLKIN as a high-speed serial interface (HSSI) refclk or as a DIFFCLK input.
- (6) The CLKIN pins in I/O Banks 3B and 8B can support single-ended I/O standard when the pins are used to clock left PLLs in non-transceiver applications.
- (7) The POR time for Standard POR ranges between 50 and 200 ms. V<sub>CCINT</sub>, V<sub>CCA</sub>, and V<sub>CCIO</sub> of I/O Banks 3, 8, and 9 must reach the recommended operating range within 50 ms.
- (8) The POR time for Fast POR ranges between 3 and 9 ms. V<sub>CCINT</sub>, V<sub>CCA</sub>, and V<sub>CCIO</sub> of I/O Banks 3, 8, and 9 must reach the recommended operating range within 3 ms.

## ESD Performance

This section lists the electrostatic discharge (ESD) voltages using the human body model (HBM) and charged device model (CDM) for Cyclone IV devices general purpose I/Os (GPIOs) and high-speed serial interface (HSSI) I/Os. Table 1-5 lists the ESD for Cyclone IV devices GPIOs and HSSI I/Os.

**Table 1-5. ESD for Cyclone IV Devices GPIOs and HSSI I/Os**

| Symbol              | Parameter  | Passing Voltage | Unit |
|---------------------|--|-----------------|------|
| V <sub>ESDHBM</sub> | ESD voltage using the HBM (GPIOs) <sup>(1)</sup> | ± 2000          | V    |
|                     | ESD using the HBM (HSSI I/Os) <sup>(2)</sup>     | ± 1000          | V    |
| V <sub>ESDCDM</sub> | ESD using the CDM (GPIOs)                        | ± 500           | V    |
|                     | ESD using the CDM (HSSI I/Os) <sup>(2)</sup>     | ± 250           | V    |

**Notes to Table 1-5:**

- (1) The passing voltage for EP4CGX15 and EP4CGX30 row I/Os is ±1000V.
- (2) This value is applicable only to Cyclone IV GX devices.

**Table 1–7. Bus Hold Parameter for Cyclone IV Devices (Part 2 of 2) <sup>(1)</sup>**

| Parameter           | Condition | V <sub>CCIO</sub> (V) |     |       |       |      |      |     |     |     |     |     |     | Unit |
|---------------------|-----------|-----------------------|-----|-------|-------|------|------|-----|-----|-----|-----|-----|-----|------|
|                     |           | 1.2                   |     | 1.5   |       | 1.8  |      | 2.5 |     | 3.0 |     | 3.3 |     |      |
|                     |           | Min                   | Max | Min   | Max   | Min  | Max  | Min | Max | Min | Max | Min | Max |      |
| Bus hold trip point | —         | 0.3                   | 0.9 | 0.375 | 1.125 | 0.68 | 1.07 | 0.7 | 1.7 | 0.8 | 2   | 0.8 | 2   | V    |

**Note to Table 1–7:**

(1) Bus hold trip points are based on the calculated input voltages from the JEDEC standard.

## OCT Specifications

Table 1–8 lists the variation of OCT without calibration across process, temperature, and voltage (PVT).

**Table 1–8. Series OCT Without Calibration Specifications for Cyclone IV Devices**

| Description                    | $V_{CCIO}$ (V) | Resistance Tolerance |   | Unit |
|--------------------------------|----------------|----------------------|---|------|
|                                |                | Commercial Maximum   | Industrial, Extended industrial, and Automotive Maximum |      |
| Series OCT without calibration | 3.0            | ±30                  | ±40   | %    |
|                                | 2.5            | ±30                  | ±40   | %    |
|                                | 1.8            | ±40                  | ±50   | %    |
|                                | 1.5            | ±50                  | ±50   | %    |
|                                | 1.2            | ±50                  | ±50   | %    |

OCT calibration is automatically performed at device power-up for OCT-enabled I/Os.

Table 1–9 lists the OCT calibration accuracy at device power-up.

**Table 1–9. Series OCT with Calibration at Device Power-Up Specifications for Cyclone IV Devices**

| Description                                    | $V_{CCIO}$ (V) | Calibration Accuracy |   | Unit |
|--|----------------|----------------------|---|------|
|  |                | Commercial Maximum   | Industrial, Extended industrial, and Automotive Maximum |      |
| Series OCT with calibration at device power-up | 3.0            | ±10                  | ±10   | %    |
|  | 2.5            | ±10                  | ±10   | %    |
|  | 1.8            | ±10                  | ±10   | %    |
|  | 1.5            | ±10                  | ±10   | %    |
|  | 1.2            | ±10                  | ±10   | %    |

## Internal Weak Pull-Up and Weak Pull-Down Resistor

Table 1-12 lists the weak pull-up and pull-down resistor values for Cyclone IV devices.

**Table 1-12. Internal Weak Pull-Up and Weak Pull-Down Resistor Values for Cyclone IV Devices <sup>(1)</sup>**

| Symbol          | Parameter  | Conditions   | Min | Typ | Max | Unit |
|-----------------|--|--|-----|-----|-----|------|
| R <sub>PU</sub> | Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if you enable the programmable pull-up resistor option | V <sub>CCIO</sub> = 3.3 V ± 5% <sup>(2), (3)</sup> | 7   | 25  | 41  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 3.0 V ± 5% <sup>(2), (3)</sup> | 7   | 28  | 47  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 2.5 V ± 5% <sup>(2), (3)</sup> | 8   | 35  | 61  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 1.8 V ± 5% <sup>(2), (3)</sup> | 10  | 57  | 108 | kΩ   |
|                 |  | V <sub>CCIO</sub> = 1.5 V ± 5% <sup>(2), (3)</sup> | 13  | 82  | 163 | kΩ   |
|                 |  | V <sub>CCIO</sub> = 1.2 V ± 5% <sup>(2), (3)</sup> | 19  | 143 | 351 | kΩ   |
| R <sub>PD</sub> | Value of the I/O pin pull-down resistor before and during configuration  | V <sub>CCIO</sub> = 3.3 V ± 5% <sup>(4)</sup>      | 6   | 19  | 30  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 3.0 V ± 5% <sup>(4)</sup>      | 6   | 22  | 36  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 2.5 V ± 5% <sup>(4)</sup>      | 6   | 25  | 43  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 1.8 V ± 5% <sup>(4)</sup>      | 7   | 35  | 71  | kΩ   |
|                 |  | V <sub>CCIO</sub> = 1.5 V ± 5% <sup>(4)</sup>      | 8   | 50  | 112 | kΩ   |

### Notes to Table 1-12:

- (1) All I/O pins have an option to enable weak pull-up except the configuration, test, and JTAG pins. The weak pull-down feature is only available for JTAG TCK.
- (2) Pin pull-up resistance values may be lower if an external source drives the pin higher than V<sub>CCIO</sub>.
- (3)  $R_{PU} = (V_{CCIO} - V_I) / I_{R_{PU}}$   
Minimum condition: -40°C; V<sub>CCIO</sub> = V<sub>CC</sub> + 5%, V<sub>I</sub> = V<sub>CC</sub> + 5% - 50 mV;  
Typical condition: 25°C; V<sub>CCIO</sub> = V<sub>CC</sub>, V<sub>I</sub> = 0 V;  
Maximum condition: 100°C; V<sub>CCIO</sub> = V<sub>CC</sub> - 5%, V<sub>I</sub> = 0 V; in which V<sub>I</sub> refers to the input voltage at the I/O pin.
- (4)  $R_{PD} = V_I / I_{R_{PD}}$   
Minimum condition: -40°C; V<sub>CCIO</sub> = V<sub>CC</sub> + 5%, V<sub>I</sub> = 50 mV;  
Typical condition: 25°C; V<sub>CCIO</sub> = V<sub>CC</sub>, V<sub>I</sub> = V<sub>CC</sub> - 5%;  
Maximum condition: 100°C; V<sub>CCIO</sub> = V<sub>CC</sub> - 5%, V<sub>I</sub> = V<sub>CC</sub> - 5%; in which V<sub>I</sub> refers to the input voltage at the I/O pin.

## Hot-Socketing

Table 1-13 lists the hot-socketing specifications for Cyclone IV devices.

**Table 1-13. Hot-Socketing Specifications for Cyclone IV Devices**

| Symbol                  | Parameter                         | Maximum             |
|-------------------------|-----------------------------------|---------------------|
| I <sub>IOPIN(DC)</sub>  | DC current per I/O pin            | 300 μA              |
| I <sub>IOPIN(AC)</sub>  | AC current per I/O pin            | 8 mA <sup>(1)</sup> |
| I <sub>XCVRTX(DC)</sub> | DC current per transceiver TX pin | 100 mA              |
| I <sub>XCVRRX(DC)</sub> | DC current per transceiver RX pin | 50 mA               |

### Note to Table 1-13:

- (1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns, |I<sub>IOPIN</sub>| = C dv/dt, in which C is the I/O pin capacitance and dv/dt is the slew rate.



During hot-socketing, the I/O pin capacitance is less than 15 pF and the clock pin capacitance is less than 20 pF.

## Schmitt Trigger Input

Cyclone IV devices support Schmitt trigger input on the TDI, TMS, TCK, nSTATUS, nCONFIG, nCE, CONF\_DONE, and DCLK pins. A Schmitt trigger feature introduces hysteresis to the input signal for improved noise immunity, especially for signals with slow edge rate. Table 1–14 lists the hysteresis specifications across the supported  $V_{CCIO}$  range for Schmitt trigger inputs in Cyclone IV devices.

**Table 1–14. Hysteresis Specifications for Schmitt Trigger Input in Cyclone IV Devices**

| Symbol        | Parameter                            | Conditions (V)   | Minimum | Unit |
|---------------|--------------------------------------|------------------|---------|------|
| $V_{SCHMITT}$ | Hysteresis for Schmitt trigger input | $V_{CCIO} = 3.3$ | 200     | mV   |
|               |                                      | $V_{CCIO} = 2.5$ | 200     | mV   |
|               |                                      | $V_{CCIO} = 1.8$ | 140     | mV   |
|               |                                      | $V_{CCIO} = 1.5$ | 110     | mV   |

## I/O Standard Specifications

The following tables list input voltage sensitivities ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ), for various I/O standards supported by Cyclone IV devices. Table 1–15 through Table 1–20 provide the I/O standard specifications for Cyclone IV devices.

**Table 1–15. Single-Ended I/O Standard Specifications for Cyclone IV Devices <sup>(1)</sup>, <sup>(2)</sup>**

| I/O Standard                | $V_{CCIO}$ (V) |     |       | $V_{IL}$ (V) |                        | $V_{IH}$ (V)           |                  | $V_{OL}$ (V)           | $V_{OH}$ (V)           | $I_{OL}$ (mA)<br><sup>(4)</sup> | $I_{OH}$ (mA)<br><sup>(4)</sup> |
|-----------------------------|----------------|-----|-------|--------------|------------------------|------------------------|------------------|------------------------|------------------------|---------------------------------|---------------------------------|
|                             | Min            | Typ | Max   | Min          | Max                    | Min                    | Max              | Max                    | Min                    |                                 |                                 |
| 3.3-V LVTTTL <sup>(3)</sup> | 3.135          | 3.3 | 3.465 | —            | 0.8                    | 1.7                    | 3.6              | 0.45                   | 2.4                    | 4                               | –4                              |
| 3.3-V LVCMOS <sup>(3)</sup> | 3.135          | 3.3 | 3.465 | —            | 0.8                    | 1.7                    | 3.6              | 0.2                    | $V_{CCIO} - 0.2$       | 2                               | –2                              |
| 3.0-V LVTTTL <sup>(3)</sup> | 2.85           | 3.0 | 3.15  | –0.3         | 0.8                    | 1.7                    | $V_{CCIO} + 0.3$ | 0.45                   | 2.4                    | 4                               | –4                              |
| 3.0-V LVCMOS <sup>(3)</sup> | 2.85           | 3.0 | 3.15  | –0.3         | 0.8                    | 1.7                    | $V_{CCIO} + 0.3$ | 0.2                    | $V_{CCIO} - 0.2$       | 0.1                             | –0.1                            |
| 2.5 V <sup>(3)</sup>        | 2.375          | 2.5 | 2.625 | –0.3         | 0.7                    | 1.7                    | $V_{CCIO} + 0.3$ | 0.4                    | 2.0                    | 1                               | –1                              |
| 1.8 V                       | 1.71           | 1.8 | 1.89  | –0.3         | $0.35 \times V_{CCIO}$ | $0.65 \times V_{CCIO}$ | 2.25             | 0.45                   | $V_{CCIO} - 0.45$      | 2                               | –2                              |
| 1.5 V                       | 1.425          | 1.5 | 1.575 | –0.3         | $0.35 \times V_{CCIO}$ | $0.65 \times V_{CCIO}$ | $V_{CCIO} + 0.3$ | $0.25 \times V_{CCIO}$ | $0.75 \times V_{CCIO}$ | 2                               | –2                              |
| 1.2 V                       | 1.14           | 1.2 | 1.26  | –0.3         | $0.35 \times V_{CCIO}$ | $0.65 \times V_{CCIO}$ | $V_{CCIO} + 0.3$ | $0.25 \times V_{CCIO}$ | $0.75 \times V_{CCIO}$ | 2                               | –2                              |
| 3.0-V PCI                   | 2.85           | 3.0 | 3.15  | —            | $0.3 \times V_{CCIO}$  | $0.5 \times V_{CCIO}$  | $V_{CCIO} + 0.3$ | $0.1 \times V_{CCIO}$  | $0.9 \times V_{CCIO}$  | 1.5                             | –0.5                            |
| 3.0-V PCI-X                 | 2.85           | 3.0 | 3.15  | —            | $0.35 \times V_{CCIO}$ | $0.5 \times V_{CCIO}$  | $V_{CCIO} + 0.3$ | $0.1 \times V_{CCIO}$  | $0.9 \times V_{CCIO}$  | 1.5                             | –0.5                            |

**Notes to Table 1–15:**

- (1) For voltage-referenced receiver input waveform and explanation of terms used in Table 1–15, refer to “Glossary” on page 1–37.
- (2) AC load  $CL = 10$  pF
- (3) For more information about interfacing Cyclone IV devices with 3.3/3.0/2.5-V LVTTTL/LVCMOS I/O standards, refer to *AN 447: Interfacing Cyclone III and Cyclone IV Devices with 3.3/3.0/2.5-V LVTTTL/LVCMOS I/O Systems*.
- (4) To meet the  $I_{OL}$  and  $I_{OH}$  specifications, you must set the current strength settings accordingly. For example, to meet the **3.3-V LVTTTL** specification (4 mA), set the current strength settings to 4 mA or higher. Setting at lower current strength may not meet the  $I_{OL}$  and  $I_{OH}$  specifications in the handbook.



**Table 1–20. Differential I/O Standard Specifications for Cyclone IV Devices <sup>(1)</sup> (Part 2 of 2)**

| I/O Standard                                | V <sub>CCIO</sub> (V) |     |       | V <sub>ID</sub> (mV) |     | V <sub>ICM</sub> (V) <sup>(2)</sup> |   |      | V <sub>OD</sub> (mV) <sup>(3)</sup> |     |     | V <sub>OS</sub> (V) <sup>(3)</sup> |      |       |
|---|-----------------------|-----|-------|----------------------|-----|-------------------------------------|---|------|-------------------------------------|-----|-----|------------------------------------|------|-------|
|   | Min                   | Typ | Max   | Min                  | Max | Min                                 | Condition   | Max  | Min                                 | Typ | Max | Min                                | Typ  | Max   |
| LVDS<br>(Column I/Os)                       | 2.375                 | 2.5 | 2.625 | 100                  | —   | 0.05                                | $D_{MAX} \leq 500 \text{ Mbps}$                       | 1.80 | 247                                 | —   | 600 | 1.125                              | 1.25 | 1.375 |
|   |                       |     |       |                      |     | 0.55                                | $500 \text{ Mbps} \leq D_{MAX} \leq 700 \text{ Mbps}$ | 1.80 |                                     |     |     |                                    |      |       |
|   |                       |     |       |                      |     | 1.05                                | $D_{MAX} > 700 \text{ Mbps}$                          | 1.55 |                                     |     |     |                                    |      |       |
| BLVDS (Row I/Os) <sup>(4)</sup>             | 2.375                 | 2.5 | 2.625 | 100                  | —   | —                                   | —   | —    | —                                   | —   | —   | —                                  | —    | —     |
| BLVDS (Column I/Os) <sup>(4)</sup>          | 2.375                 | 2.5 | 2.625 | 100                  | —   | —                                   | —   | —    | —                                   | —   | —   | —                                  | —    | —     |
| mini-LVDS (Row I/Os) <sup>(5)</sup>         | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 300                                 | —   | 600 | 1.0                                | 1.2  | 1.4   |
| mini-LVDS (Column I/Os) <sup>(5)</sup>      | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 300                                 | —   | 600 | 1.0                                | 1.2  | 1.4   |
| RSDS <sup>®</sup> (Row I/Os) <sup>(5)</sup> | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.5   |
| RSDS (Column I/Os) <sup>(5)</sup>           | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.5   |
| PPDS (Row I/Os) <sup>(5)</sup>              | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.4   |
| PPDS (Column I/Os) <sup>(5)</sup>           | 2.375                 | 2.5 | 2.625 | —                    | —   | —                                   | —   | —    | 100                                 | 200 | 600 | 0.5                                | 1.2  | 1.4   |

**Notes to Table 1–20:**

- (1) For an explanation of terms used in Table 1–20, refer to “Glossary” on page 1–37.
- (2) V<sub>IN</sub> range:  $0 \text{ V} \leq V_{IN} \leq 1.85 \text{ V}$ .
- (3) R<sub>L</sub> range:  $90 \leq R_L \leq 110 \Omega$ .
- (4) There are no fixed V<sub>IN</sub>, V<sub>OD</sub>, and V<sub>OS</sub> specifications for BLVDS. They depend on the system topology.
- (5) The Mini-LVDS, RSDS, and PPDS standards are only supported at the output pins.
- (6) The LVPECL I/O standard is only supported on dedicated clock input pins. This I/O standard is not supported for output pins.

## Power Consumption

Use the following methods to estimate power for a design:

- the Excel-based EPE
- the Quartus® II PowerPlay power analyzer feature

The interactive Excel-based EPE is used prior to designing the device to get a magnitude estimate of the device power. The Quartus II PowerPlay power analyzer provides better quality estimates based on the specifics of the design after place-and-route is complete. The PowerPlay power analyzer can apply a combination of user-entered, simulation-derived, and estimated signal activities that, combined with detailed circuit models, can yield very accurate power estimates.



For more information about power estimation tools, refer to the *Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in volume 3 of the *Quartus II Handbook*.

## Switching Characteristics

This section provides performance characteristics of Cyclone IV core and periphery blocks for commercial grade devices.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The upper-right hand corner of these tables show the designation as “Preliminary”.
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

**Table 1–21. Transceiver Specification for Cyclone IV GX Devices (Part 4 of 4)**

| Symbol/<br>Description                           | Conditions | C6                                 |     |        | C7, I7 |     |        | C8  |     |        | Unit |
|--|------------|------------------------------------|-----|--------|--------|-----|--------|-----|-----|--------|------|
|  |            | Min                                | Typ | Max    | Min    | Typ | Max    | Min | Typ | Max    |      |
| PLD-Transceiver Interface                        |            |                                    |     |        |        |     |        |     |     |        |      |
| Interface speed<br>(F324 and smaller<br>package) | —          | 25                                 | —   | 125    | 25     | —   | 125    | 25  | —   | 125    | MHz  |
| Interface speed<br>(F484 and larger<br>package)  | —          | 25                                 | —   | 156.25 | 25     | —   | 156.25 | 25  | —   | 156.25 | MHz  |
| Digital reset pulse<br>width                     | —          | Minimum is 2 parallel clock cycles |     |        |        |     |        |     |     |        |      |

**Notes to Table 1–21:**

- (1) This specification is valid for transmitter output jitter specification with a maximum total jitter value of 112 ps, typically for 3.125 Gbps SRIO and XAUI protocols.
- (2) The minimum `reconfig_clk` frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter Only** mode. The minimum `reconfig_clk` frequency is 37.5 MHz if the transceiver channel is configured in **Receiver Only** or **Receiver and Transmitter** mode.
- (3) The device cannot tolerate prolonged operation at this absolute maximum.
- (4) The rate matcher supports only up to  $\pm 300$  parts per million (ppm).
- (5) Supported for the F169 and F324 device packages only.
- (6) Supported for the F484, F672, and F896 device packages only. Pending device characterization.
- (7) To support CDR ppm tolerance greater than  $\pm 300$  ppm, implement ppm detector in user logic and configure CDR to Manual Lock Mode.
- (8) Asynchronous spread-spectrum clocking is not supported.
- (9) For the EP4CGX30 (F484 package only), EP4CGX50, and EP4CGX75 devices, the CDR ppl tolerance is  $\pm 200$  ppm.
- (10) Time taken until `p11_locked` goes high after `p11_powerdown` deasserts.
- (11) Time that the CDR must be kept in lock-to-reference mode after `rx_analogreset` deasserts and before `rx_locktodata` is asserted in manual mode.
- (12) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode (Figure 1–2), or after `rx_freqlocked` signal goes high in automatic mode (Figure 1–3).
- (13) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode.
- (14) Time taken to recover valid data after the `rx_freqlocked` signal goes high in automatic mode.
- (15) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

Figure 1-4 shows the differential receiver input waveform.

**Figure 1-4. Receiver Input Waveform**

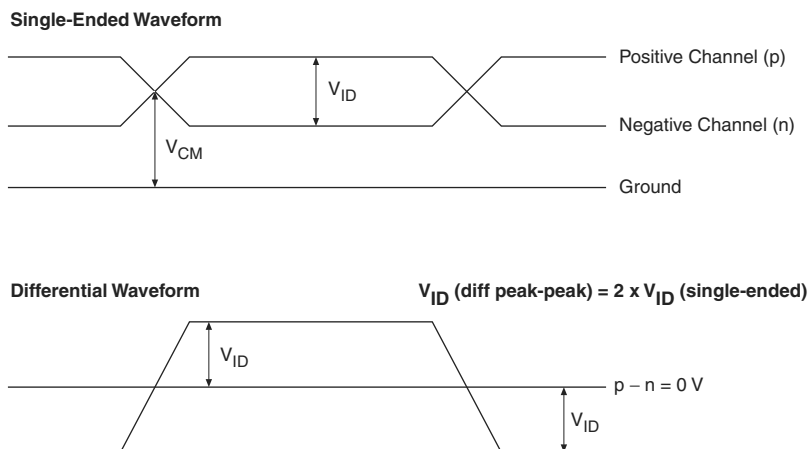


Figure 1-5 shows the transmitter output waveform.

**Figure 1-5. Transmitter Output Waveform**

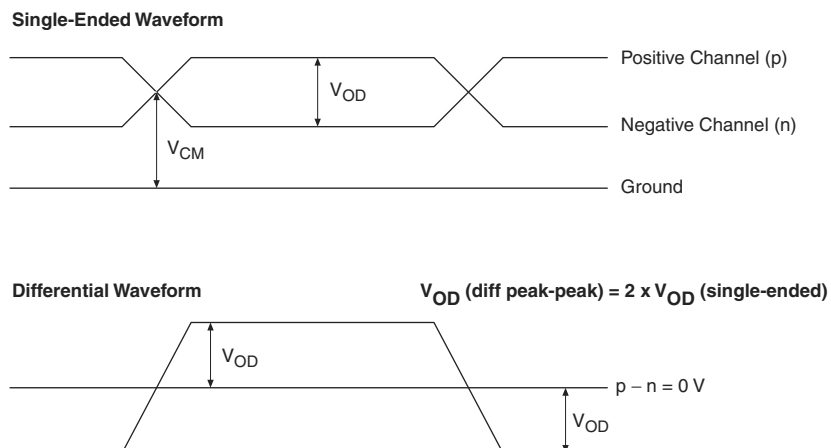


Table 1-22 lists the typical  $V_{OD}$  for Tx term that equals 100  $\Omega$ .

**Table 1-22. Typical  $V_{OD}$  Setting, Tx Term = 100  $\Omega$**

| Symbol  | $V_{OD}$ Setting (mV) |     |     |       |      |      |
|---|-----------------------|-----|-----|-------|------|------|
|   | 1                     | 2   | 3   | 4 (1) | 5    | 6    |
| $V_{OD}$ differential peak to peak typical (mV) | 400                   | 600 | 800 | 900   | 1000 | 1200 |

**Note to Table 1-22:**

(1) This setting is required for compliance with the PCIe protocol.

Table 1–23 lists the Cyclone IV GX transceiver block AC specifications.

**Table 1–23. Transceiver Block AC Specification for Cyclone IV GX Devices <sup>(1), (2)</sup>**

| Symbol/<br>Description  | Conditions         | C6     |     |       | C7, I7 |     |       | C8     |     |       | Unit |
|---|--------------------|--------|-----|-------|--------|-----|-------|--------|-----|-------|------|
|   |                    | Min    | Typ | Max   | Min    | Typ | Max   | Min    | Typ | Max   |      |
| PCIe Transmit Jitter Generation <sup>(3)</sup>                    |                    |        |     |       |        |     |       |        |     |       |      |
| Total jitter at 2.5 Gbps (Gen1)                                   | Compliance pattern | —      | —   | 0.25  | —      | —   | 0.25  | —      | —   | 0.25  | UI   |
| PCIe Receiver Jitter Tolerance <sup>(3)</sup>                     |                    |        |     |       |        |     |       |        |     |       |      |
| Total jitter at 2.5 Gbps (Gen1)                                   | Compliance pattern | > 0.6  |     |       | > 0.6  |     |       | > 0.6  |     |       | UI   |
| GIGE Transmit Jitter Generation <sup>(4)</sup>                    |                    |        |     |       |        |     |       |        |     |       |      |
| Deterministic jitter (peak-to-peak)                               | Pattern = CRPAT    | —      | —   | 0.14  | —      | —   | 0.14  | —      | —   | 0.14  | UI   |
| Total jitter (peak-to-peak)                                       | Pattern = CRPAT    | —      | —   | 0.279 | —      | —   | 0.279 | —      | —   | 0.279 | UI   |
| GIGE Receiver Jitter Tolerance <sup>(4)</sup>                     |                    |        |     |       |        |     |       |        |     |       |      |
| Deterministic jitter tolerance (peak-to-peak)                     | Pattern = CJPAT    | > 0.4  |     |       | > 0.4  |     |       | > 0.4  |     |       | UI   |
| Combined deterministic and random jitter tolerance (peak-to-peak) | Pattern = CJPAT    | > 0.66 |     |       | > 0.66 |     |       | > 0.66 |     |       | UI   |

**Notes to Table 1–23:**

- (1) Dedicated `refclk` pins were used to drive the input reference clocks.
- (2) The jitter numbers specified are valid for the stated conditions only.
- (3) The jitter numbers for PIPE are compliant to the PCIe Base Specification 2.0.
- (4) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.

## Core Performance Specifications

The following sections describe the clock tree specifications, PLLs, embedded multiplier, memory block, and configuration specifications for Cyclone IV Devices.

### Clock Tree Specifications

Table 1–24 lists the clock tree specifications for Cyclone IV devices.

**Table 1–24. Clock Tree Performance for Cyclone IV Devices (Part 1 of 2)**

| Device  | Performance |       |     |                    |                    |       |                    |     | Unit |
|---------|-------------|-------|-----|--------------------|--------------------|-------|--------------------|-----|------|
|         | C6          | C7    | C8  | C8L <sup>(1)</sup> | C9L <sup>(1)</sup> | I7    | I8L <sup>(1)</sup> | A7  |      |
| EP4CE6  | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE10 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE15 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE22 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE30 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |
| EP4CE40 | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | 402 | MHz  |

**Table 1–24. Clock Tree Performance for Cyclone IV Devices (Part 2 of 2)**

| Device    | Performance |       |     |                    |                    |       |                    |    | Unit |
|-----------|-------------|-------|-----|--------------------|--------------------|-------|--------------------|----|------|
|           | C6          | C7    | C8  | C8L <sup>(1)</sup> | C9L <sup>(1)</sup> | I7    | I8L <sup>(1)</sup> | A7 |      |
| EP4CE55   | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | —  | MHz  |
| EP4CE75   | 500         | 437.5 | 402 | 362                | 265                | 437.5 | 362                | —  | MHz  |
| EP4CE115  | —           | 437.5 | 402 | 362                | 265                | 437.5 | 362                | —  | MHz  |
| EP4CGX15  | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX22  | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX30  | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX50  | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX75  | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX110 | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |
| EP4CGX150 | 500         | 437.5 | 402 | —                  | —                  | 437.5 | —                  | —  | MHz  |

**Note to Table 1–24:**

(1) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades.

## PLL Specifications

Table 1–25 lists the PLL specifications for Cyclone IV devices when operating in the commercial junction temperature range (0°C to 85°C), the industrial junction temperature range (–40°C to 100°C), the extended industrial junction temperature range (–40°C to 125°C), and the automotive junction temperature range (–40°C to 125°C). For more information about the PLL block, refer to “Glossary” on page 1–37.

**Table 1–25. PLL Specifications for Cyclone IV Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol  | Parameter   | Min | Typ | Max   | Unit |
|---|---|-----|-----|-------|------|
| $f_{IN}^{(3)}$  | Input clock frequency (–6, –7, –8 speed grades)             | 5   | —   | 472.5 | MHz  |
|   | Input clock frequency (–8L speed grade)                     | 5   | —   | 362   | MHz  |
|   | Input clock frequency (–9L speed grade)                     | 5   | —   | 265   | MHz  |
| $f_{INPFD}$   | PFD input frequency   | 5   | —   | 325   | MHz  |
| $f_{VCO}^{(4)}$                                       | PLL internal VCO operating range                            | 600 | —   | 1300  | MHz  |
| $f_{INDUTY}$  | Input clock duty cycle                                      | 40  | —   | 60    | %    |
| $t_{INJITTER\_CCJ}^{(5)}$                             | Input clock cycle-to-cycle jitter<br>$F_{REF} \geq 100$ MHz | —   | —   | 0.15  | UI   |
|   | $F_{REF} < 100$ MHz   | —   | —   | ±750  | ps   |
| $f_{OUT\_EXT}$ (external clock output) <sup>(3)</sup> | PLL output frequency  | —   | —   | 472.5 | MHz  |
| $f_{OUT}$ (to global clock)                           | PLL output frequency (–6 speed grade)                       | —   | —   | 472.5 | MHz  |
|   | PLL output frequency (–7 speed grade)                       | —   | —   | 450   | MHz  |
|   | PLL output frequency (–8 speed grade)                       | —   | —   | 402.5 | MHz  |
|   | PLL output frequency (–8L speed grade)                      | —   | —   | 362   | MHz  |
|   | PLL output frequency (–9L speed grade)                      | —   | —   | 265   | MHz  |
| $t_{OUTDUTY}$   | Duty cycle for external clock output (when set to 50%)      | 45  | 50  | 55    | %    |
| $t_{LOCK}$  | Time required to lock from end of device configuration      | —   | —   | 1     | ms   |

## Embedded Multiplier Specifications

Table 1–26 lists the embedded multiplier specifications for Cyclone IV devices.

**Table 1–26. Embedded Multiplier Specifications for Cyclone IV Devices**

| Mode                   | Resources Used        | Performance |            |     |          |     | Unit |
|------------------------|-----------------------|-------------|------------|-----|----------|-----|------|
|                        | Number of Multipliers | C6          | C7, I7, A7 | C8  | C8L, I8L | C9L |      |
| 9 × 9-bit multiplier   | 1                     | 340         | 300        | 260 | 240      | 175 | MHz  |
| 18 × 18-bit multiplier | 1                     | 287         | 250        | 200 | 185      | 135 | MHz  |

## Memory Block Specifications

Table 1–27 lists the M9K memory block specifications for Cyclone IV devices.

**Table 1–27. Memory Block Performance Specifications for Cyclone IV Devices**

| Memory    | Mode                               | Resources Used |            | Performance |            |     |          |     | Unit |
|-----------|------------------------------------|----------------|------------|-------------|------------|-----|----------|-----|------|
|           |                                    | LEs            | M9K Memory | C6          | C7, I7, A7 | C8  | C8L, I8L | C9L |      |
| M9K Block | FIFO 256 × 36                      | 47             | 1          | 315         | 274        | 238 | 200      | 157 | MHz  |
|           | Single-port 256 × 36               | 0              | 1          | 315         | 274        | 238 | 200      | 157 | MHz  |
|           | Simple dual-port 256 × 36 CLK      | 0              | 1          | 315         | 274        | 238 | 200      | 157 | MHz  |
|           | True dual port 512 × 18 single CLK | 0              | 1          | 315         | 274        | 238 | 200      | 157 | MHz  |

## Configuration and JTAG Specifications

Table 1–28 lists the configuration mode specifications for Cyclone IV devices.

**Table 1–28. Passive Configuration Mode Specifications for Cyclone IV Devices <sup>(1)</sup>**

| Programming Mode                           | V <sub>CCINT</sub> Voltage Level (V) | DCLK f <sub>MAX</sub> | Unit |
|--|--------------------------------------|-----------------------|------|
| Passive Serial (PS)                        | 1.0 <sup>(3)</sup>                   | 66                    | MHz  |
|  | 1.2                                  | 133                   | MHz  |
| Fast Passive Parallel (FPP) <sup>(2)</sup> | 1.0 <sup>(3)</sup>                   | 66                    | MHz  |
|  | 1.2 <sup>(4)</sup>                   | 100                   | MHz  |

**Notes to Table 1–28:**

- (1) For more information about PS and FPP configuration timing parameters, refer to the *Configuration and Remote System Upgrades in Cyclone IV Devices* chapter.
- (2) FPP configuration mode supports all Cyclone IV E devices (except for E144 package devices) and EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 only.
- (3) V<sub>CCINT</sub> = 1.0 V is only supported for Cyclone IV E 1.0 V core voltage devices.
- (4) Cyclone IV E devices support 1.2 V V<sub>CCINT</sub>. Cyclone IV E 1.2 V core voltage devices support 133 MHz DCLK f<sub>MAX</sub> for EP4CE6, EP4CE10, EP4CE15, EP4CE22, EP4CE30, and EP4CE40 only.

**Table 1-34. True LVDS Transmitter Timing Specifications for Cyclone IV Devices <sup>(1)</sup>, <sup>(3)</sup>**

| Symbol                                    | Modes | C6  |     | C7, I7 |       | C8, A7 |       | C8L, I8L |     | C9L |     | Unit |
|---|-------|-----|-----|--------|-------|--------|-------|----------|-----|-----|-----|------|
|   |       | Min | Max | Min    | Max   | Min    | Max   | Min      | Max | Min | Max |      |
| f <sub>HCLK</sub> (input clock frequency) | ×10   | 5   | 420 | 5      | 370   | 5      | 320   | 5        | 320 | 5   | 250 | MHz  |
|   | ×8    | 5   | 420 | 5      | 370   | 5      | 320   | 5        | 320 | 5   | 250 | MHz  |
|   | ×7    | 5   | 420 | 5      | 370   | 5      | 320   | 5        | 320 | 5   | 250 | MHz  |
|   | ×4    | 5   | 420 | 5      | 370   | 5      | 320   | 5        | 320 | 5   | 250 | MHz  |
|   | ×2    | 5   | 420 | 5      | 370   | 5      | 320   | 5        | 320 | 5   | 250 | MHz  |
|   | ×1    | 5   | 420 | 5      | 402.5 | 5      | 402.5 | 5        | 362 | 5   | 265 | MHz  |
| HSIODR                                    | ×10   | 100 | 840 | 100    | 740   | 100    | 640   | 100      | 640 | 100 | 500 | Mbps |
|   | ×8    | 80  | 840 | 80     | 740   | 80     | 640   | 80       | 640 | 80  | 500 | Mbps |
|   | ×7    | 70  | 840 | 70     | 740   | 70     | 640   | 70       | 640 | 70  | 500 | Mbps |
|   | ×4    | 40  | 840 | 40     | 740   | 40     | 640   | 40       | 640 | 40  | 500 | Mbps |
|   | ×2    | 20  | 840 | 20     | 740   | 20     | 640   | 20       | 640 | 20  | 500 | Mbps |
|   | ×1    | 10  | 420 | 10     | 402.5 | 10     | 402.5 | 10       | 362 | 10  | 265 | Mbps |
| t <sub>DUTY</sub>                         | —     | 45  | 55  | 45     | 55    | 45     | 55    | 45       | 55  | 45  | 55  | %    |
| TCCS                                      | —     | —   | 200 | —      | 200   | —      | 200   | —        | 200 | —   | 200 | ps   |
| Output jitter (peak to peak)              | —     | —   | 500 | —      | 500   | —      | 550   | —        | 600 | —   | 700 | ps   |
| t <sub>LOCK</sub> <sup>(2)</sup>          | —     | —   | 1   | —      | 1     | —      | 1     | —        | 1   | —   | 1   | ms   |

**Notes to Table 1-34:**

- (1) Cyclone IV E—true LVDS transmitter is only supported at the output pin of Row I/O Banks 1, 2, 5, and 6.  
Cyclone IV GX—true LVDS transmitter is only supported at the output pin of Row I/O Banks 5 and 6.
- (2) t<sub>LOCK</sub> is the time required for the PLL to lock from the end-of-device configuration.
- (3) Cyclone IV E 1.0 V core voltage devices only support C8L, C9L, and I8L speed grades. Cyclone IV E 1.2 V core voltage devices only support C6, C7, C8, I7, and A7 speed grades. Cyclone IV GX devices only support C6, C7, C8, and I7 speed grades.

**Table 1-35. Emulated LVDS Transmitter Timing Specifications for Cyclone IV Devices <sup>(1)</sup>, <sup>(3)</sup> (Part 1 of 2)**

| Symbol                                    | Modes | C6  |       | C7, I7 |       | C8, A7 |       | C8L, I8L |     | C9L |     | Unit |
|---|-------|-----|-------|--------|-------|--------|-------|----------|-----|-----|-----|------|
|   |       | Min | Max   | Min    | Max   | Min    | Max   | Min      | Max | Min | Max |      |
| f <sub>HCLK</sub> (input clock frequency) | ×10   | 5   | 320   | 5      | 320   | 5      | 275   | 5        | 275 | 5   | 250 | MHz  |
|   | ×8    | 5   | 320   | 5      | 320   | 5      | 275   | 5        | 275 | 5   | 250 | MHz  |
|   | ×7    | 5   | 320   | 5      | 320   | 5      | 275   | 5        | 275 | 5   | 250 | MHz  |
|   | ×4    | 5   | 320   | 5      | 320   | 5      | 275   | 5        | 275 | 5   | 250 | MHz  |
|   | ×2    | 5   | 320   | 5      | 320   | 5      | 275   | 5        | 275 | 5   | 250 | MHz  |
|   | ×1    | 5   | 402.5 | 5      | 402.5 | 5      | 402.5 | 5        | 362 | 5   | 265 | MHz  |
| HSIODR                                    | ×10   | 100 | 640   | 100    | 640   | 100    | 550   | 100      | 550 | 100 | 500 | Mbps |
|   | ×8    | 80  | 640   | 80     | 640   | 80     | 550   | 80       | 550 | 80  | 500 | Mbps |
|   | ×7    | 70  | 640   | 70     | 640   | 70     | 550   | 70       | 550 | 70  | 500 | Mbps |
|   | ×4    | 40  | 640   | 40     | 640   | 40     | 550   | 40       | 550 | 40  | 500 | Mbps |
|   | ×2    | 20  | 640   | 20     | 640   | 20     | 550   | 20       | 550 | 20  | 500 | Mbps |
|   | ×1    | 10  | 402.5 | 10     | 402.5 | 10     | 402.5 | 10       | 362 | 10  | 265 | Mbps |



## IOE Programmable Delay

Table 1–40 and Table 1–41 list the IOE programmable delay for Cyclone IV E 1.0 V core voltage devices.

**Table 1–40. IOE Programmable Delay on Column Pins for Cyclone IV E 1.0 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter   | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |             |       |       | Unit |
|---|-----------------------------|-------------------|------------|-------------|-------|-------------|-------|-------|------|
|   |                             |                   |            | Fast Corner |       | Slow Corner |       |       |      |
|   |                             |                   |            | C8L         | I8L   | C8L         | C9L   | I8L   |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 2.054       | 1.924 | 3.387       | 4.017 | 3.411 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 2.010       | 1.875 | 3.341       | 4.252 | 3.367 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.641       | 0.631 | 1.111       | 1.377 | 1.124 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.971       | 0.931 | 1.684       | 2.298 | 1.684 | ns   |

**Notes to Table 1–40:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.

**Table 1–41. IOE Programmable Delay on Row Pins for Cyclone IV E 1.0 V Core Voltage Devices <sup>(1), (2)</sup>**

| Parameter   | Paths Affected              | Number of Setting | Min Offset | Max Offset  |       |             |       |       | Unit |
|---|-----------------------------|-------------------|------------|-------------|-------|-------------|-------|-------|------|
|   |                             |                   |            | Fast Corner |       | Slow Corner |       |       |      |
|   |                             |                   |            | C8L         | I8L   | C8L         | C9L   | I8L   |      |
| Input delay from pin to internal cells                          | Pad to I/O dataout to core  | 7                 | 0          | 2.057       | 1.921 | 3.389       | 4.146 | 3.412 | ns   |
| Input delay from pin to input register                          | Pad to I/O input register   | 8                 | 0          | 2.059       | 1.919 | 3.420       | 4.374 | 3.441 | ns   |
| Delay from output register to output pin                        | I/O output register to pad  | 2                 | 0          | 0.670       | 0.623 | 1.160       | 1.420 | 1.168 | ns   |
| Input delay from dual-purpose clock pin to fan-out destinations | Pad to global clock network | 12                | 0          | 0.960       | 0.919 | 1.656       | 2.258 | 1.656 | ns   |

**Notes to Table 1–41:**

- (1) The incremental values for the settings are generally linear. For the exact values for each setting, use the latest version of the Quartus II software.
- (2) The minimum and maximum offset timing numbers are in reference to setting **0** as available in the Quartus II software.

Table 1-46. Glossary (Part 2 of 5)

| Letter   | Term          | Definitions   |
|----------|---------------|---|
| <b>J</b> | JTAG Waveform | <p>The diagram illustrates the JTAG waveform with the following timing parameters:</p> <ul style="list-style-type: none"> <li><math>t_{JCP}</math>: Time from TCK rising edge to TMS falling edge.</li> <li><math>t_{JCH}</math>: Time from TCK rising edge to TDI falling edge.</li> <li><math>t_{JCL}</math>: Time from TCK rising edge to TDI rising edge.</li> <li><math>t_{JPSU\_TDI}</math>: Time from TCK rising edge to TDI setup time.</li> <li><math>t_{JPSU\_TMS}</math>: Time from TCK rising edge to TMS setup time.</li> <li><math>t_{JPH}</math>: Time from TCK rising edge to TMS hold time.</li> <li><math>t_{JPZX}</math>: Time from TCK rising edge to TDO setup time.</li> <li><math>t_{JPCO}</math>: Time from TCK rising edge to TDO output delay.</li> <li><math>t_{JPXZ}</math>: Time from TCK rising edge to TDO hold time.</li> <li><math>t_{JSSU}</math>: Time from TCK rising edge to Signal to be Captured setup time.</li> <li><math>t_{JSH}</math>: Time from TCK rising edge to Signal to be Captured hold time.</li> <li><math>t_{JSZX}</math>: Time from TCK rising edge to Signal to be Driven setup time.</li> <li><math>t_{JSCO}</math>: Time from TCK rising edge to Signal to be Driven output delay.</li> <li><math>t_{JSXZ}</math>: Time from TCK rising edge to Signal to be Driven hold time.</li> </ul> |
| <b>K</b> | —             | —   |
| <b>L</b> | —             | —   |
| <b>M</b> | —             | —   |
| <b>N</b> | —             | —   |
| <b>O</b> | —             | —   |
| <b>P</b> | PLL Block     | <p>The following highlights the PLL specification parameters:</p> <p>The diagram shows the internal structure of the PLL block, including the following components and signals:</p> <ul style="list-style-type: none"> <li><b>Inputs:</b> CLK, Core Clock.</li> <li><b>Internal Blocks:</b> Switchover, PFD (Phase-Frequency Divider), CP (Charge Pump), LF (Loop Filter), VCO (Voltage-Controlled Oscillator), Counters C0..C4, GCLK (Global Clock).</li> <li><b>Outputs:</b> CLKOUT Pins, <math>f_{OUT\_EXT}</math>, <math>f_{OUT}</math>.</li> <li><b>Reconfigurable Components (shaded gray):</b> Switchover, PFD, CP, LF, VCO, Counters C0..C4, GCLK.</li> <li><b>Other Components:</b> M (Multiplier), Phase tap.</li> <li><b>Signals:</b> <math>f_{IN}</math>, <math>f_{INPFD}</math>, <math>f_{VCO}</math>.</li> </ul> <p><b>Key:</b></p> <ul style="list-style-type: none"> <li>Reconfigurable in User Mode</li> </ul>   |
| <b>Q</b> | —             | —   |

Table 1-46. Glossary (Part 4 of 5)

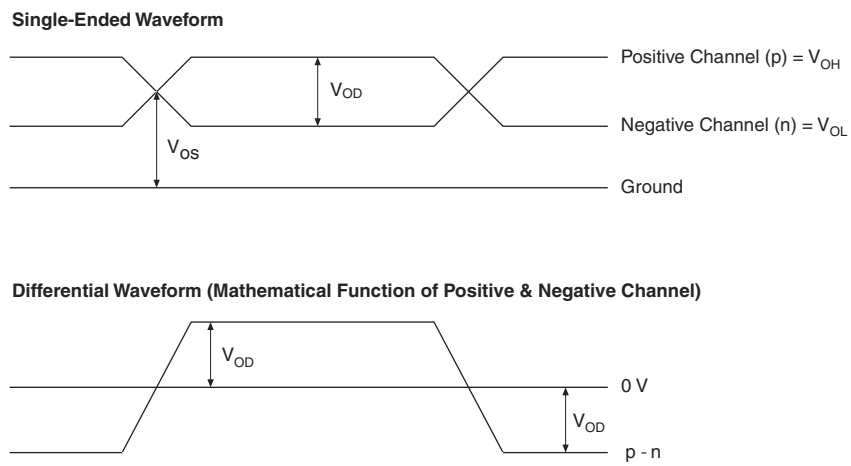
| Letter | Term                           | Definitions   |
|--------|--------------------------------|---|
| T      | $t_C$                          | High-speed receiver and transmitter input and output clock period.  |
|        | Channel-to-channel-skew (TCCS) | High-speed I/O block: The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew. The clock is included in the TCCS measurement.       |
|        | $t_{cin}$                      | Delay from the clock pad to the I/O input register.   |
|        | $t_{CO}$                       | Delay from the clock pad to the I/O output.   |
|        | $t_{cout}$                     | Delay from the clock pad to the I/O output register.  |
|        | $t_{DUTY}$                     | High-speed I/O block: Duty cycle on high-speed transmitter output clock.  |
|        | $t_{FALL}$                     | Signal high-to-low transition time (80–20%).  |
|        | $t_H$                          | Input register hold time.   |
|        | Timing Unit Interval (TUI)     | High-speed I/O block: The timing budget allowed for skew, propagation delays, and data sampling window. (TUI = $1/(\text{Receiver Input Clock Frequency Multiplication Factor}) = t_C/w$ ). |
|        | $t_{INJITTER}$                 | Period jitter on the PLL clock input.   |
|        | $t_{OUTJITTER\_DEDCLK}$        | Period jitter on the dedicated clock output driven by a PLL.  |
|        | $t_{OUTJITTER\_IO}$            | Period jitter on the general purpose I/O driven by a PLL.   |
|        | $t_{pllcin}$                   | Delay from the PLL inclk pad to the I/O input register.   |
|        | $t_{pllcout}$                  | Delay from the PLL inclk pad to the I/O output register.  |
|        | Transmitter Output Waveform    | <p>Transmitter output waveforms for the LVDS, mini-LVDS, PPDS and RSDS Differential I/O Standards:</p>  |
|        | $t_{RISE}$                     | Signal low-to-high transition time (20–80%).  |
|        | $t_{SU}$                       | Input register setup time.  |
| U      | —                              | —   |

Table 1-46. Glossary (Part 5 of 5)

| Letter   | Term            | Definitions  |
|----------|-----------------|--|
| <b>V</b> | $V_{CM(DC)}$    | DC common mode input voltage.  |
|          | $V_{DIF(AC)}$   | AC differential input voltage: The minimum AC input differential voltage required for switching.   |
|          | $V_{DIF(DC)}$   | DC differential input voltage: The minimum DC input differential voltage required for switching.   |
|          | $V_{ICM}$       | Input common mode voltage: The common mode of the differential signal at the receiver.   |
|          | $V_{ID}$        | Input differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.                                  |
|          | $V_{IH}$        | Voltage input high: The minimum positive voltage applied to the input that is accepted by the device as a logic high.  |
|          | $V_{IH(AC)}$    | High-level AC input voltage.   |
|          | $V_{IH(DC)}$    | High-level DC input voltage.   |
|          | $V_{IL}$        | Voltage input low: The maximum positive voltage applied to the input that is accepted by the device as a logic low.  |
|          | $V_{IL(AC)}$    | Low-level AC input voltage.  |
|          | $V_{IL(DC)}$    | Low-level DC input voltage.  |
|          | $V_{IN}$        | DC input voltage.  |
|          | $V_{OCM}$       | Output common mode voltage: The common mode of the differential signal at the transmitter.   |
|          | $V_{OD}$        | Output differential voltage swing: The difference in voltage between the positive and complementary conductors of a differential transmission at the transmitter. $V_{OD} = V_{OH} - V_{OL}$ . |
|          | $V_{OH}$        | Voltage output high: The maximum positive voltage from an output that the device considers is accepted as the minimum positive high level.   |
|          | $V_{OL}$        | Voltage output low: The maximum positive voltage from an output that the device considers is accepted as the maximum positive low level.   |
|          | $V_{OS}$        | Output offset voltage: $V_{OS} = (V_{OH} + V_{OL}) / 2$ .  |
|          | $V_{OX(AC)}$    | AC differential output cross point voltage: the voltage at which the differential output signals must cross.   |
|          | $V_{REF}$       | Reference voltage for the SSTL and HSTL I/O standards.   |
|          | $V_{REF(AC)}$   | AC input reference voltage for the SSTL and HSTL I/O standards. $V_{REF(AC)} = V_{REF(DC)} + \text{noise}$ . The peak-to-peak AC noise on $V_{REF}$ must not exceed 2% of $V_{REF(DC)}$ .      |
|          | $V_{REF(DC)}$   | DC input reference voltage for the SSTL and HSTL I/O standards.  |
|          | $V_{SWING(AC)}$ | AC differential input voltage: AC input differential voltage required for switching. For the SSTL differential I/O standard, refer to Input Waveforms.   |
|          | $V_{SWING(DC)}$ | DC differential input voltage: DC input differential voltage required for switching. For the SSTL differential I/O standard, refer to Input Waveforms.   |
|          | $V_{TT}$        | Termination voltage for the SSTL and HSTL I/O standards.   |
|          | $V_X(AC)$       | AC differential input cross point voltage: The voltage at which the differential input signals must cross.   |
| <b>W</b> | —               | —  |
| <b>X</b> | —               | —  |
| <b>Y</b> | —               | —  |
| <b>Z</b> | —               | —  |

**Table 1–47. Document Revision History**

| Date          | Version | Changes   |
|---------------|---------|---|
| February 2010 | 1.1     | <ul style="list-style-type: none"><li>■ Updated Table 1–3 through Table 1–44 to include information for Cyclone IV E devices and Cyclone IV GX devices for Quartus II software version 9.1 SP1 release.</li><li>■ Minor text edits.</li></ul> |
| November 2009 | 1.0     | Initial release.  |